

X9317 Low Noise, Low Power, 100 Taps

Data Sheet

December 16, 2009

```
FN8183.6
```

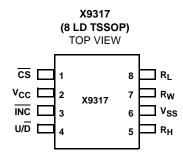
Digitally Controlled Potentiometer (XDCP™)

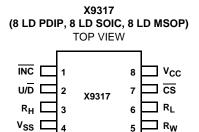
The Intersil X9317 is a digitally controlled potentiometer (XDCPTM). The device consists of a resistor array, wiper switches, a control section, and nonvolatile memory. The wiper position is controlled by a 3-wire interface.

The potentiometer is implemented by a resistor array composed of 99 resistive elements and a wiper switching network. Between each element and at either end are tap points accessible to the wiper terminal. The position of the wiper element is controlled by the \overline{CS} , U/\overline{D} , and \overline{INC} inputs. The position of the wiper can be stored in nonvolatile memory and then be recalled upon a subsequent power-up operation.

The device can be used as a three-terminal potentiometer for voltage control or as a two-terminal variable resistor for current control in a wide variety of applications.

Pinouts





Features

- Solid-State Potentiometer
- 3-Wire Serial Up/Down Interface
- 100 Wiper Tap Points
 - Wiper Position Stored in Nonvolatile Memory and Recalled on Power-up
- 99 Resistive Elements
 - Temperature Compensated
 - End-to-end Resistance Range ±20%
- Low Power CMOS
 - V_{CC} = 2.7V to 5.5V, and 5V ±10%
 - Standby Current <5µA
- High Reliability
 - Endurance, 100,000 Data Changes per Bit
 - Register Data Retention, 100 years
- R_{TOTAL} Values = 1k Ω , 10k Ω , 50k Ω , 100k Ω
- Packages
 - 8 Ld SOIC, PDIP, TSSOP, and MSOP
- Pb-Free Available (RoHS Compliant)

Applications

- LCD Bias Control
- DC Bias Adjustment
- Gain and Offset Trim
- Laser Diode Bias Control
- Voltage Regulator Output Control

Ordering Information

PART NUMBER	PART MARKING	V _{CC} LIMITS (V)	R _{TOTAL} (kΩ)	TEMPERATURE RANGE (°C)	PACKAGE	PKG. DWG. #
X9317ZM8* (Note 2)	AFG	5 ±10%	1	0 to +70	8 Ld MSOP	M8.118
X9317ZM8Z* (Note 1)	DDA			0 to +70	8 Ld MSOP (Pb-free)	M8.118
X9317ZM8I* (Note 2)	AFI			-40 to +85	8 Ld MSOP	M8.118
X9317ZM8IZ* (Note 1)	DCY			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
X9317ZP (Note 2)	X9317ZP			0 to +70	8 Ld PDIP	MDP0031
X9317ZS8* (Note 2)	X9317Z			0 to +70	8 Ld SOIC	M8.15E
X9317ZS8Z* (Note 1)	X9317Z Z			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
X9317ZS8I* (Note 2)	9317W F			-40 to +85	8 Ld SOIC	M8.15E
X9317ZS8IZ* (Note 1)	X9317Z Z I			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
X9317ZV8* (Note 2)	9317Z			0 to +70	8 Ld TSSOP	M8.173
X9317ZV8Z* (Note 1)	9317Z Z			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
X9317ZV8I* (Note 2)	317Z I			-40 to +85	8 Ld TSSOP	M8.173
X9317ZV8IZ* (Note 1)	9317Z IZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
X9317WM8T1 (Note 2)	ABF		10	0 to +70	8 Ld MSOP	M8.118
X9317WM8Z* (Note 1)	DCW			0 to +70	8 Ld MSOP (Pb-free)	M8.118
X9317WM8I*	ADS			-40 to +85	8 Ld MSOP	M8.118
X9317WM8 (Note 2)	ABF			-40 to +85	8 Ld MSOP	M8.118
X9317WM8IZ* (Note 1)	DCT			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
X9317WP	X9317WP			0 to +70	8 Ld PDIP	MDP0031
X9317WPI (Note 2)	X9317WP I			-40 to +85	8 Ld PDIP	MDP0031
X9317WS8*	X9317W			0 to +70	8 Ld SOIC	M8.15E
X9317WS8Z* (Note 1)	X9317W Z			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
X9317WS8I	X9317W I			-40 to +85	8 Ld SOIC	M8.15E
X9317WS8IT1 (Note 2)	X9317W I			-40 to +85	8 Ld SOIC	M8.15E
X9317WS8IZ* (Note 1)	X9317W ZI			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
X9317WV8	9317W			0 to +70	8 Ld TSSOP	M8.173
X9317WV8T1 (Note 2)	9317W			0 to +70	8 Ld TSSOP	M8.173
X9317WV8T2 (Note 2)	9317W			0 to +70	8 Ld TSSOP	M8.173
X9317WV8Z* (Note 1)	9317W Z			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
X9317WV8I	317W I			-40 to +85	8 Ld TSSOP	M8.173
X9317WV8IT1 (Note 2)	317W I			-40 to +85	8 Ld TSSOP	M8.173
X9317WV8IZ* (Note 1)	9317W IZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
X9317UM8* (Note 2)	AEC			0 to +70	8 Ld MSOP	M8.118
X9317UM8Z* (Note 1)	DCS			0 to +70	8 Ld MSOP (Pb-free)	M8.118
X9317UM8I* (Note 2)	AFE			-40 to +85	8 Ld MSOP	M8.118
X9317UM8IZ* (Note 1)	DCR			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
X9317UP (Note 2)	X9317UP		50	0 to +70	8 Ld PDIP	MDP0031
X9317UPI (Note 2)	X9317UP I			-40 to +85	8 Ld PDIP	MDP0031
X9317US8* (Note 2)	X9317U			0 to +70	8 Ld SOIC	M8.15E
X9317US8Z* (Note 1)	X9317U Z			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
X9317US8I* (Note 2)	X9317U I			-40 to +85	8 Ld SOIC	M8.15E
X9317US8IZ* (Note 1)	X9317U ZI			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E

Ordering Information (Continued)

PART NUMBER	PART MARKING	V _{CC} LIMITS (V)	R _{TOTAL} (kΩ)	TEMPERATURE RANGE (°C)	PACKAGE	PKG. DWG. #
X9317UV8* (Note 2)	9317U	5 ±10%	50	0 to +70	8 Ld TSSOP	M8.173
X9317UV8Z* (Note 1)	9317U Z			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
X9317UV8I* (Note 2)	317U I			-40 to +85	8 Ld TSSOP	M8.173
X9317UV8IZ* (Note 1)	9317U IZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
X9317TM8*, ** (Note 2)	AGD		100	0 to +70	8 Ld MSOP	M8.118
X9317TM8Z* (Note 1)	DCN			0 to +70	8 Ld MSOP (Pb-free)	M8.118
X9317TM8I*, ** (Note 2)	AGF			-40 to +85	8 Ld MSOP	M8.118
X9317TM8IZ* (Note 1)	DCL			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
X9317TP (Note 2)	X9317TP			0 to +70	8 Ld PDIP	MDP0031
X9317TPI (Note 2)	X9317TP I			-40 to +85	8 Ld PDIP	MDP0031
X9317TS8 (Note 2)	X9317T			0 to +70	8 Ld SOIC	M8.15E
X9317TS8Z (Note 1)	X9317T Z			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
X9317TS8I (Note 2)	X9317T I			-40 to +85	8 Ld SOIC	M8.15E
X9317TS8IZ (Note 1)	X9317T ZI			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
X9317TV8*, ** (Note 2)	9317T			0 to +70	8 Ld TSSOP	M8.173
X9317TV8Z* (Note 1)	9317T Z			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
X9317TV8I*, ** (Note 2)	317T I			-40 to +85	8 Ld TSSOP	M8.173
X9317TV8IZ* (Note 1)	9317T IZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
X9317ZM8-2.7* (Note 2)	AFH	2.7 to 5.5	1	0 to +70	8 Ld MSOP	M8.118
X9317ZM8Z-2.7* (Note 1)	AOA			0 to +70	8 Ld MSOP (Pb-free)	M8.118
X9317ZM8I-2.7* (Note 2)	AFJ			-40 to +85	8 Ld MSOP	M8.118
X9317ZM8IZ-2.7* (Note 1)	DCZ			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
X9317ZS8-2.7* (Note 2)	X9317Z F			0 to +70	8 Ld SOIC	M8.15E
X9317ZS8Z-2.7* (Note 1)	X9317Z ZF			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
X9317ZS8I-2.7* (Note 2)	X9317Z G			-40 to +85	8 Ld SOIC	M8.15E
X9317ZS8IZ-2.7* (Note 1)	X9317Z ZG			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
X9317ZV8-2.7* (Note 2)	317Z F			0 to +70	8 Ld TSSOP	M8.173
X9317ZV8Z-2.7* (Note 1)	9317Z FZ			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
X9317ZV8I-2.7*, ** (Note 2)	317Z G			-40 to +85	8 Ld TSSOP	M8.173
X9317ZV8IZ-2.7* (Note 1)	9317Z GZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
X9317WM8-2.7* (Note 2)	ACZ		10	0 to +70	8 Ld MSOP	M8.118
X9317WM8Z-2.7* (Note 1)	DCX			0 to +70	8 Ld MSOP (Pb-free)	M8.118
X9317WM8I-2.7	ADT			-40 to +85	8 Ld MSOP	M8.118
X9317WM8I-2.7T1 (Note 2)	ADT			-40 to +85	8 Ld MSOP	M8.118
X9317WM8IZ-2.7* (Note 2)	DCU			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
X9317WP-2.7 (Note 2)	X9317WP F			0 to +70	8 Ld PDIP	MDP0031
X9317WPI-2.7 (Note 2)	X9317WP G			-40 to +85	8 Ld PDIP	MDP0031
X9317WS8-2.7	X9317W F			0 to +70	8 Ld SOIC	M8.15E
X9317WS8-2.7T1 (Note 2)	X9317W F			0 to +70	8 Ld SOIC	M8.15E
X9317WS8Z-2.7* (Note 1)	X9317W ZF			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
X9317WS8I-2.7** (Note 2)	X9317W G			-40 to +85	8 Ld SOIC	M8.15E
X9317WS8I-2.7T1	X9317W G			-40 to +85	8 Ld SOIC	M8.15E

Ordering Information (Continued)

(9317WV8-2.7' (Note 2) 317W F (9317WV82-2.7' (Note 1) 9317W FZ (9317WV82-2.7' (Note 2) 317W G (9317WV82-2.7' (Note 2) AKZ (9317W82-2.7' (Note 2) AKZ (9317W82-2.7' (Note 2) AKZ (9317W82-2.7' (Note 2) AKD (9317UM82-7' (Note 2) AFF (9317UM82-7' (Note 2) AFF (9317UM82-2.7' (Note 2) X9317U F (9317UM2-2.7' (Note 2) X9317U F (9317UP2-7' (Note 2) X9317U F (9317U82-2.7' (Note 1) X9317U F (9317U82-2.7' (Note 2) X9317U F (9317U82-2.7' (Note 1) S17U F (9317U82-2.7' (Note 1) S17U F (9317TM2-2.7' (Note 2	PART NUMBER	PART MARKING	V _{CC} LIMITS (V)	R _{TOTAL} (kΩ)	TEMPERATURE RANGE (°C)	PACKAGE	PKG. DWG. #
49317WV8Z-2.7' (Note 1) 9317W FZ (3317WV8J-2.7', ''(Note 2) 317W G (3317WV8J-2.7', ''(Note 2) 317W G (3317WV8J-2.7', ''(Note 2) AED (3317UM82.2.7', (Note 1) AOB (3317UM82.2.7', (Note 2) AFF (3317UM82.2.7', (Note 2) AFF (3317UM82.2.7', (Note 2) AFF (3317UM82.2.7', (Note 2) X3317U F (3317UM82.2.7', (Note 2) X3317U F (3317UB2.2.7', (Note 2) X3317U F (3317UB2.2.7', (Note 2) X3317U F (3317U82.2.7', (Note 1) X3317U ZG (3317U82.2.7', (Note 2) X317U F	X9317WS8IZ-2.7* (Note 1)	X9317W ZG	2.7 to 5.5	10	-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
400 to +85 8 Ld TSSOP M8.173 400 to +85 8 Ld MSOP M8.173 400 to +85 8 Ld MSOP M8.118 0 to +70 8 Ld MSOP M8.118 400 to +85 8 Ld SOIC M8.158 400 to +85 8 Ld SOIC M8.156 400 to +85 8 Ld SOIC M8.173 400 to +85 8 Ld SOIC M8.173 400 to +85 8 Ld TSSOP M8.173 400 to +85 8 Ld TSSOP M8.173 <t< td=""><td>X9317WV8-2.7* (Note 2)</td><td>317W F</td><td></td><td></td><td>0 to +70</td><td>8 Ld TSSOP</td><td>M8.173</td></t<>	X9317WV8-2.7* (Note 2)	317W F			0 to +70	8 Ld TSSOP	M8.173
400 17 WV8IZ-2.7* (Note) AKZ (3317UM6-2.7* (Note 2) AED (3317UM6-2.7* (Note 1) AOB (3317UM6-2.7* (Note 1) AOB (3317UM6-2.7* (Note 2) AFF (3317UM6-2.7* (Note 2) AFF (3317UM6-2.7* (Note 2) X9317UF (30317UP.2.7* (Note 2) X9317UF (30317UP.2.7* (Note 2) X9317UF (30317UP.2.7* (Note 2) X9317UF (30317US8-2.7* (Note 1)) X9317U F (30317US8-2.7* (Note 2) X9317U F (30317US8-2.7* (Note 1)) X9317U G (30317US8-2.7* (Note 1)) X9317U G (30317US8-2.7* (Note 1)) X9317U ZG (30317US8-2.7* (Note 2) X9317U G (30317US8-2.7* (Note 2) X9317U G (30317US8-2.7* (Note 2) X9317U G (30317US8-2.7* (Note 1)) 9317U GZ (30317TM82-2.7* (Note 1)) DCM (30317TM82-2.7* (Note 1)) DCM <t< td=""><td>X9317WV8Z-2.7* (Note 1)</td><td>9317W FZ</td><td></td><td></td><td>0 to +70</td><td>8 Ld TSSOP (Pb-free)</td><td>M8.173</td></t<>	X9317WV8Z-2.7* (Note 1)	9317W FZ			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
(93)71UM8-2.7* (Note 2) AED (93)71UM8-2.7* (Note 1) AOB (93)71UM82-2.7* (Note 1) AOB (93)71UM82-2.7* (Note 2) AFF (93)71UM82-2.7* (Note 2) AFF (93)71UM82-2.7* (Note 2) X9317UF (93)71UM82-2.7* (Note 2) X9317UF (93)71UP2.7* (Note 2) X9317UF (93)71UP2.7* (Note 2) X9317UF (93)71UP2.7* (Note 2) X9317UF (93)71US2.2.7* (Note 2) X9317UF (93)71US2.2.7* (Note 2) X9317U F (93)71US2.2.7* (Note 1) X9317U F (93)71UV82.2.7* (Note 1) S917U FZ (93)71TW82.2.7* (Note 2) X9317T FZ (93)71TM82.2.7* (Note 2) X9317T FE (93)71TM82.2.7* (Note 2) X9317T FE <td>X9317WV8I-2.7*, ** (Note 2)</td> <td>317W G</td> <td></td> <td></td> <td>-40 to +85</td> <td>8 Ld TSSOP</td> <td>M8.173</td>	X9317WV8I-2.7*, ** (Note 2)	317W G			-40 to +85	8 Ld TSSOP	M8.173
(93)17UM82-2.7* (Note 1) AOB (93)17UM82-2.7* (Note 2) AFF (93)17UM81-2.7* (Note 2) AFF (93)17UM81-2.7* (Note 2) X9317U F (93)17UB82-2.7* (Note 2) X9317U F (93)17UP2.7 (Note 2) X9317U F (93)17UB2.2.7* (Note 2) X9317U F (93)17UB2.2.7* (Note 2) X9317U F (93)17US82.2.7* (Note 1) X9317U F (93)17US82.2.7* (Note 1) X9317U F (93)17US82.2.7* (Note 2) X9317U G (93)17US82.2.7* (Note 1) X9317U ZF (93)17US2.2.7* (Note 2) 317U F (93)17US2.2.7* (Note 1) X9317U ZG (93)17US2.2.7* (Note 2) 317U F (93)17US2.2.7* (Note 2) 317U F (93)17US2.2.7* (Note 2) 317U F (93)17US2.2.7* (Note 2) 317U G (93)17US2.2.7* (Note 1) 9317U G (93)17UM3.2.2.7* (Note 2) AGG (93)17TM3.2.2.7* (Note 2) AGG (93)17TM3.2.2.7* (Note 2) X9317TP G (93)17TM3.2.2.7* (Note 2) X9317TP G (93)17TM3.2.2.7* (Note 2) X9317T ZF <	X9317WV8IZ-2.7* (Note)	AKZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
(93)17UM8I-2.7*, ** (Note 2) AFF (93)17UM8I-2.7*, (Note 1) AOH (93)17UM8I-2.7* (Note 2) X9317U F (93)17UP-2.7 (Note 2) X9317U F (93)17UP-2.7 (Note 2) X9317U F (93)17US82-2.7* (Note 1) X9317U F (93)17US82-2.7* (Note 1) X9317U F (93)17US82-2.7* (Note 1) X9317U ZF (93)17US82-2.7* (Note 1) X9317U ZF (93)17US82-2.7* (Note 1) X9317U ZF (93)17US82-2.7* (Note 2) X9317U ZF (93)17US82-2.7* (Note 1) X9317U ZG (93)17US2-2.7* (Note 2) 317U F (93)17US2-2.7* (Note 2) 317U F (93)17US2-2.7* (Note 2) 317U F (93)17US2-2.7* (Note 1) 9317U GZ (93)17US2-2.7* (Note 1) 9317U GZ (93)17US2-2.7* (Note 1) 9317U GZ (93)17US2-2.7* (Note 2) AGE (93)17TM8-2.7*, ** (Note 2) AGE (93)17TM8-2.7*, ** (Note 2) X9317T F (93)17TM8-2.7*, ** (Note 2) X9317T F (93)17TS2 X9317T F (93)17TS2 X9317T F <t< td=""><td>X9317UM8-2.7* (Note 2)</td><td>AED</td><td></td><td></td><td>0 to +70</td><td>8 Ld MSOP</td><td>M8.118</td></t<>	X9317UM8-2.7* (Note 2)	AED			0 to +70	8 Ld MSOP	M8.118
(9317UMBIZ-2.7* (Note 1) AOH (9317UMBIZ-2.7* (Note 2) X9317U F (9317UP-2.7 (Note 2) X9317U F (9317UP-2.7 (Note 2) X9317U F (9317UP-2.7 (Note 2) X9317U F (9317USE-2.7* (Note 1) X9317U F (9317USE-2.7* (Note 1) X9317U F (9317USE-2.7* (Note 1) X9317U G (9317USE-2.7* (Note 2) X9317U G (9317USE-2.7* (Note 1) X9317U F (9317UVE-2.7* (Note 2) X9317U F (9317UVE-2.7* (Note 1) X9317U F (9317UVE-2.7* (Note 1) X9317U F (9317UVE-2.7* (Note 1) S17U F (9317UVE-2.7* (Note 1) S17U F (9317UVE-2.7* (Note 1) S17U G (9317UVE-2.7* (Note 1) S17U G (9317TVE-2.7* (Note 1) S17U G (9317TVE-2.7* (Note 1) DCP (9317TVE-2.7* (Note 1) DCP (9317TP-2.7 (Note 2) X9317T F (9317TP-2.7 (Note 2) X9317T F (9317TP-2.7* (Note 1) X9317T F (9317TP-2.7* (Note 1) X9317T F (9317TP-2.7* (No	X9317UM8Z-2.7* (Note 1)	AOB			0 to +70	8 Ld MSOP (Pb-free)	M8.118
System System System State	X9317UM8I-2.7*, ** (Note 2)	AFF			-40 to +85	8 Ld MSOP	M8.118
X9317UP-2.7 (Note 2) X9317UP F X9317UP1-2.7 (Note 2) X9317UP G X9317UP1-2.7 (Note 2) X9317U ZF X9317US82-2.7* (Note 1) X9317U ZF X9317US82-2.7* (Note 1) X9317U G X9317US82-2.7* (Note 1) X9317U ZG X9317UV82-2.7* (Note 1) X9317U ZG X9317UV82-2.7* (Note 1) X9317U ZG X9317UV82-2.7* (Note 1) 9317U ZG X9317UV82-2.7* (Note 1) 9317U ZG X9317UV82-2.7* (Note 1) 9317U GZ X9317TW82-2.7* (Note 1) 9317U GZ X9317TM82-2.7* (Note 1) 9317U GZ X9317TM82-2.7* (Note 1) DCP X9317TM82-2.7* (Note 1) DCP X9317TM81-2.7* (Note 2) AGG X9317TP G X9317TP F X9317TP2.7 (Note 2) X9317TP G X9317TP2.7 (Note 2) X9317TP G X9317TP32-2.7* (Note 1) X9317T ZF X9317TP32-2.7* (Note 1) X9317T ZF X9317TP32-2.7* (Note 1) X9317T ZG X9317TS32-2.7* (Note 1) X9317T ZG X9317TS32-2.7* (Note 1) X9317T ZG X9317TV82-2.7* (Note 1) X9317T ZG	K9317UM8IZ-2.7* (Note 1)	AOH			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
40 10	X9317US8-2.7* (Note 2)	X9317U F		50	0 to +70	8 Ld SOIC	M8.15E
(9317US8Z-2.7* (Note 1) X9317U ZF (9317US8Z-2.7* (Note 1) X9317U G (9317US8Z-2.7* (Note 2) X9317U G (9317US8Z-2.7* (Note 1) X9317U ZG (9317US8Z-2.7* (Note 2) 317U F (9317US8Z-2.7* (Note 1) 9317U FZ (9317US8Z-2.7* (Note 2) 317U F (9317US8Z-2.7* (Note 1) 9317U FZ (9317US8Z-2.7* (Note 1) 9317U G (9317US8Z-2.7* (Note 1) 9317U GZ (9317US8Z-2.7* (Note 1) 9317U GZ (9317US8Z-2.7* (Note 2) 317U G (9317US8Z-2.7* (Note 1) 9317U GZ (9317US8Z-2.7* (Note 1) 9317U GZ (9317TM8-2.7*, ** (Note 2) AGE (9317TM8-2.7*, ** (Note 2) AGE (9317TM8/2.7.* (Note 1) DCP (9317TM8/2.7.* (Note 2) X9317TP F (9317TM8/2.7.* (Note 2) X9317TP F (9317TS8/2.7.* (Note 1)) DCM (9317TS8/2.7.* (Note 1)) X9317T ZF (9317TS8/2.7.* (Note 1)) X9317T ZF (9317TS8/2.7.* (Note 1)) X9317T ZF (9317TS8/2.7.* (Note 1)) X9317T ZG (9317TS8/2.7.* (Note 1)) X9317T ZG	X9317UP-2.7 (Note 2)	X9317UP F			0 to +70	8 Ld PDIP	MDP0031
4017US81-2.7*, ** (Note 2) X9317U G 4010 + 85 8 Ld SOIC M8.15E 4010 + 85 8 Ld SOIC (Pb-free) M8.15E 4010 + 85 8 Ld SOIC (Pb-free) M8.15E 4010 + 85 8 Ld SOIC (Pb-free) M8.173 4010 + 85 8 Ld SOIC (Pb-free) M8.173 4010 + 85 8 Ld TSSOP M8.173 4010 + 85 8 Ld TSSOP (Pb-free) M8.173 4010 + 85 8 Ld MSOP (Pb-free) M8.118 49317TM8L-2.7* (Note 1) DCP M8.118 49317TM8L-2.7* (Note 1) DCP M8.118 49317TM8L-2.7* (Note 2) X9317TP F 49317TS8L-2.7* (Note 2) X9317T F 49317TS8L-2.7* (Note 2) X9317T F 49317TS8L-2.7* (Note 1) X9317T ZG 49317TS8L-2.7* (Note 1) X9317T ZG 49317TS8L-2.7* (Not	X9317UPI-2.7 (Note 2)	X9317UP G			-40 to +85	8 Ld PDIP	MDP0031
(9317US8IZ-2.7* (Note 1) X9317U ZG (9317UV82.2.7* (Note 2)) 317U F (9317UV82.2.7* (Note 1)) 9317U FZ (9317UV82.2.7* (Note 1)) 9317U FZ (9317UV81.2.7*, ** (Note 2)) 317U G (9317UV81.2.7*, (Note 1)) 9317U GZ (9317UV81.2.7*, ** (Note 2)) AGE (9317TM8-2.7*, ** (Note 2)) AGE (9317TM81-2.7*, ** (Note 2)) AGE (9317TM81-2.7*, ** (Note 1)) DCP (9317TM81-2.7*, ** (Note 2)) AGG (9317TM81-2.7*, ** (Note 2)) AGG (9317TM81-2.7*, ** (Note 2)) X9317TP F (9317TS8-2.7*, (Note 1)) DCM (9317TS8-2.7*, ** (Note 2)) X9317TP G (9317TS8-2.7*, ** (Note 2)) X9317T F (9317TS8-2.7*, ** (Note 2)) X9317T ZF (9317TS8-2.7*, ** (Note 2)) X9317T ZF (9317TS8-2.7*, ** (Note 2)) X9317T ZG (9317TV8-2.7*, ** (Note 2)) X9317T FZ (9317TV8-2.7*, ** (Note 1)) X9317T FZ (9317TS8-2.7*, ** (Note 2)) X9317T ZG (9317TV8-2.7*, ** (Note 2)) X917T FZ (9317TV8-2.7*, ** (Note 2)) X917T FZ	X9317US8Z-2.7* (Note 1)	X9317U ZF			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
(9317UV8-2.7* (Note 2) 317U F (9317UV82-2.7* (Note 1) 9317U FZ (9317UV82-2.7* (Note 1) 9317U FZ (9317UV82-2.7* (Note 1) 9317U G (9317UV82-2.7* (Note 1) 9317U GZ (9317UV82-2.7* (Note 1) 9317U GZ (9317TM82-2.7* (Note 2) AGE (9317TM82-2.7* (Note 1) DCP (9317TM81-2.7*, ** (Note 2) AGG (9317TM81-2.7*, ** (Note 1) DCP (9317TM81-2.7*, (Note 1)) DCM (9317TM81-2.7*, (Note 1)) DCM (9317TM82-2.7* (Note 1)) DCM (9317TP-2.7 (Note 2)) X9317TP F (9317TS82-2.7* (Note 1)) DCM (9317TS82-2.7* (Note 1)) X9317T F (9317TS82-2.7* (Note 1)) X9317T F (9317TS82-2.7* (Note 2)) X9317T F (9317TS82-2.7* (Note 1)) X9317T ZG (9317TS82-2.7* (Note 2)) X9317T ZG (9317TV82-2.7* (Note 1)) X9317T FZ (9317TV82-2.7* (Note 1)) X9317T FZ (9317TV82-2.7* (Note 1)) X9317T ZG (9317TV82-2.7* (Note 1)) 317T F (9317TV82-2.7* (Note 1)) 317T FZ	(9317US8I-2.7*, ** (Note 2)	X9317U G			-40 to +85	8 Ld SOIC	M8.15E
(9317UV8Z-2.7* (Note 1) 9317U FZ (9317UV8Z-2.7* (Note 1) 9317U GZ (9317UV8Z-2.7* (Note 1) 9317U GZ (9317TM8-2.7*, ** (Note 2) AGE (9317TM8-2.7*, ** (Note 1) DCP (9317TM81-2.7*, ** (Note 2) AGE (9317TM81-2.7*, ** (Note 1) DCP (9317TM81-2.7*, ** (Note 2) AGG (9317TM81-2.7*, ** (Note 2)) AGG (9317TM81-2.7*, ** (Note 2)) AGG (9317TM81-2.7*, (Note 1)) DCM (9317TM81-2.7*, (Note 2)) X9317TP F (9317TN82-2.7* (Note 1)) DCM (9317TS82-2.7*, (Note 2)) X9317TP G (9317TS82-2.7*, (Note 1)) X9317T FE (9317TS81-2.7*, ** (Note 2)) X9317T G (9317TV82-2.7* (Note 1)) X9317T ZG (9317TV82-2.7* (Note 1)) X9317T FZ (9317TV82-2.7* (Note 1)) Y317T FZ (9317TV82-2.7* (Note 1)) <	K9317US8IZ-2.7* (Note 1)	X9317U ZG			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
(9317UV8I-2.7*, ** (Note 2) 317U G (9317UV8I-2.7*, (** (Note 1)) 9317U GZ (9317UV8I-2.7*, (Note 1)) 9317U GZ (9317TM8-2.7*, (Note 2)) AGE (9317TM8-2.7*, (Note 1)) DCP (9317TM8I-2.7*, (Note 1)) DCP (9317TM8I-2.7*, (Note 1)) DCP (9317TM8I-2.7*, (Note 1)) DCP (9317TM8I-2.7*, (Note 1)) DCM (9317TM8I-2.7*, (Note 1)) DCM (9317TM8I-2.7*, (Note 2)) X9317TP F (9317TS8-2.7*, (Note 2)) X9317TP G (9317TS8I-2.7*, (Note 1)) X9317T F (9317TS8I-2.7*, (Note 1)) X9317T G (9317TS8I-2.7*, (Note 1)) X9317T G (9317TV8-2.7*, (Note 1)) X9317T ZG (9317TV8-2.7*, (Note 1)) X9317T ZG (9317TV8-2.7*, (Note 1)) X9317T ZG (9317TV8-2.7*, (Note 1)) X9317T FZ (9317TV8-2.7*, (Note 1)) X9317T FZ (9317TV8-2.7*, (Note 1)) X9317T ZG (9317TV8-2.7*, (Note 1)) X9317T FZ (9317TV8-2.7*, (Note 1)) Y317T FZ (9317TV8-2.7*, (Note 1)) X9317T ZG (9317TV8-2.7*, (Note 1))	K9317UV8-2.7* (Note 2)	317U F			0 to +70	8 Ld TSSOP	M8.173
(9317UV8IZ-2.7* (Note 1) 9317U GZ (9317TM8-2.7*, ** (Note 2) AGE (9317TM8-2.7*, ** (Note 1) DCP (9317TM81-2.7*, ** (Note 1) DCP (9317TM81-2.7*, ** (Note 2) AGG (9317TM81-2.7*, ** (Note 1) DCP (9317TM81-2.7*, ** (Note 1)) DCM (9317TM81-2.7*, ** (Note 1)) DCM (9317TP-2.7 (Note 1)) DCM (9317TS8-2.7*, (Note 1)) DCM (9317TS8-2.7*, (Note 2)) X9317TP G (9317TS8-2.7*, (Note 1)) X9317T F (9317TS8-2.7*, (Note 1)) X9317T ZF (9317TS8-2.7*, (Note 2)) X9317T G (9317TS8-2.7*, (Note 1)) X9317T ZG (9317TV8-2.7*, (Note 1)) 317T F (9317TV8-2.7*, (Note 1)) 317T FZ (9317TV8-2.7*, (Note 1)) 317T FZ <td>K9317UV8Z-2.7* (Note 1)</td> <td>9317U FZ</td> <td></td> <td></td> <td>0 to +70</td> <td>8 Ld TSSOP (Pb-free)</td> <td>M8.173</td>	K9317UV8Z-2.7* (Note 1)	9317U FZ			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
(9317TM8-2.7*, ** (Note 2) AGE (9317TM8-2.7*, ** (Note 1) DCP (9317TM82-2.7* (Note 1)) DCP (9317TM81-2.7*, ** (Note 2)) AGG (9317TM81-2.7*, ** (Note 1)) DCM (9317TM81-2.7* (Note 1)) DCM (9317TP-2.7 (Note 2)) X9317TP F (9317TS8-2.7*, ** (Note 2)) X9317TP G (9317TS82-2.7* (Note 1)) X9317T F (9317TS82-2.7*, ** (Note 2)) X9317T F (9317TS81-2.7*, ** (Note 2)) X9317T G (9317TS81-2.7*, ** (Note 2)) X9317T ZF (9317TS81-2.7*, ** (Note 2)) X9317T ZF (9317TV82-2.7*, ** (Note 2)) X9317T ZF (9317TV82-2.7*, ** (Note 2)) X9317T ZG (9317TV82-2.7*, ** (Note 2)) 317T F (9317TV82-2.7*, ** (Note 2)) 317T FZ	X9317UV8I-2.7*, ** (Note 2)	317U G			-40 to +85	8 Ld TSSOP	M8.173
(9317TM8Z-2.7* (Note 1) DCP (9317TM8I-2.7*, ** (Note 2) AGG (9317TM8I-2.7*, ** (Note 1) DCM (9317TM8IZ-2.7* (Note 1) DCM (9317TP-2.7 (Note 2) X9317TP F (9317TS8-2.7*, ** (Note 2) X9317TP G (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, ** (Note 1) X9317T F (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8I-2.7*, ** (Note 2)) X9317T G (9317TS8I-2.7*, ** (Note 2)) X9317T G (9317TV8-2.7*, ** (Note 1)) X9317T ZG (9317TV8-2.7*, ** (Note 1)) X9317T ZG (9317TV8-2.7*, ** (Note 1)) X9317T F (9317TV8-2.7*, ** (Note 2)) X17T F (9317TV8-2.7*, ** (Note 1)) X9317T ZG (9317TV8-2.7*, ** (Note 1)) 317T F (9317TV8-2.7*, ** (Note 1)) 317T FZ (9317TV8-2.7*, ** (Note 1)) 317T FZ (9317TV8-2.7*, ** (Note 2)) 317T G	K9317UV8IZ-2.7* (Note 1)	9317U GZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173
(9317TM8I-2.7*, ** (Note 2) AGG (9317TM8I-2.7*, (Note 1)) DCM (9317TP-2.7 (Note 2)) X9317TP F (9317TP-2.7 (Note 2)) X9317TP G (9317TS8-2.7*, (Note 2)) X9317TF G (9317TS8-2.7*, (Note 2)) X9317T F (9317TS8-2.7*, (Note 2)) X9317T F (9317TS8-2.7*, (Note 1)) X9317T ZF (9317TS8I-2.7*, (Note 1)) X9317T G (9317TS8I-2.7*, (Note 1)) X9317T ZG (9317TV82-2.7*, (Note 1)) 317T F (9317TV82-2.7*, (Note 1)) 9317T FZ (9317TV82-2.7*, (Note 1)) 317T F (9317TV82-2.7*, (Note 2)) 317T F (9317TV82-2.7*, (Note 1)) 9317T FZ (9317TV82-2.7*, (Note 2)) 317T F (9317TV82-2.7*, (Note 1)) 9317T FZ (9317TV82-2.7*, (Note 1)) 9317T FZ (9317TV82-2.7*, (Note 2)) 317T F (9317TV81-2.7*, ** (Note 2)) 317T G (9317TV81-2.7*, ** (Note 2)) 317T G (9317TV81-2.7*, ** (Note 2)) 317T G	X9317TM8-2.7*, ** (Note 2)	AGE		100	0 to +70	8 Ld MSOP	M8.118
(9317TM8IZ-2.7* (Note 1) DCM (9317TM8IZ-2.7* (Note 1) X9317TP F (9317TP-2.7 (Note 2) X9317TP G (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, ** (Note 1) X9317T ZF (9317TS8I-2.7*, ** (Note 2) X9317T G (9317TS8I-2.7*, ** (Note 2) X9317T ZF (9317TS8I-2.7*, ** (Note 2) X9317T ZG (9317TV8-2.7*, ** (Note 2) 317T F (9317TV8-2.7*, ** (Note 2) 317T FZ (9317TV8-2.7*, ** (Note 2) 317T FZ (9317TV8-2.7*, ** (Note 2) 317T G	X9317TM8Z-2.7* (Note 1)	DCP			0 to +70	8 Ld MSOP (Pb-free)	M8.118
(9317TP-2.7 (Note 2) X9317TP F (9317TP-2.7 (Note 2) X9317TP G (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, ** (Note 1) X9317T ZF (9317TS8I-2.7*, ** (Note 2) X9317T G (9317TS8I-2.7*, ** (Note 1) X9317T ZG (9317TV8-2.7*, ** (Note 2) 317T F (9317TV8-2.7*, ** (Note 2) 317T F (9317TV8-2.7*, ** (Note 2) 317T FZ (9317TV8-2.7*, ** (Note 2) 317T FZ (9317TV8-2.7*, ** (Note 2) 317T G	X9317TM8I-2.7*, ** (Note 2)	AGG			-40 to +85	8 Ld MSOP	M8.118
(9317TPI-2.7 (Note 2) X9317TP G (9317TS8-2.7*, ** (Note 2) X9317T F (9317TS82-2.7* (Note 1)) X9317T ZF (9317TS81-2.7*, ** (Note 2)) X9317T G (9317TS81-2.7*, ** (Note 1)) X9317T ZG (9317TV8-2.7*, ** (Note 2)) 317T F (9317TV8-2.7*, ** (Note 2)) 317T F (9317TV8-2.7*, ** (Note 2)) 317T FZ (9317TV81-2.7*, ** (Note 2)) 317T G (9317TV81-2.7*, ** (Note 2)) 317T G (9317TV81-2.7*, ** (Note 2)) 317T G	X9317TM8IZ-2.7* (Note 1)	DCM			-40 to +85	8 Ld MSOP (Pb-free)	M8.118
(9317TS8-2.7*, ** (Note 2) X9317T F (9317TS8-2.7*, (Note 1) X9317T ZF (9317TS8I-2.7*, ** (Note 2) X9317T G (9317TS8I-2.7*, ** (Note 1) X9317T ZG (9317TV8-2.7*, ** (Note 1) X9317T ZG (9317TV8-2.7*, ** (Note 2) 317T F (9317TV8-2.7*, ** (Note 1) 9317T FZ (9317TV8-2.7*, ** (Note 1) 9317T FZ (9317TV8-2.7*, ** (Note 2) 317T F (9317TV8-2.7*, ** (Note 2) 317T G	X9317TP-2.7 (Note 2)	X9317TP F			0 to +70	8 Ld PDIP	MDP0031
(9317TS8Z-2.7* (Note 1) X9317T ZF (9317TS8I-2.7*, ** (Note 2) X9317T G (9317TS8I-2.7* (Note 1)) X9317T ZG (9317TV8-2.7*, ** (Note 2)) 317T F (9317TV82-2.7* (Note 1)) 9317T FZ (9317TV81-2.7*, ** (Note 2)) 317T FZ (9317TV81-2.7*, ** (Note 2)) 317T G (9317TV81-2.7*, ** (Note 2)) 317T G	(9317TPI-2.7 (Note 2)	X9317TP G			-40 to +85	8 Ld PDIP	MDP0031
(9317TS8I-2.7*, ** (Note 2) X9317T G -40 to +85 8 Ld SOIC M8.15E (9317TS8IZ-2.7* (Note 1) X9317T ZG (9317TV8-2.7*, ** (Note 2) 317T F 0 to +70 8 Ld TSSOP M8.173 0 to +70 8 Ld TSSOP (Pb-free) M8.173 (9317TV8I-2.7*, ** (Note 1) 9317T FZ 0 to +70 8 Ld TSSOP (Pb-free) M8.173 (9317TV8I-2.7*, ** (Note 2) 317T G -40 to +85 8 Ld TSSOP M8.173	X9317TS8-2.7*, ** (Note 2)	X9317T F			0 to +70	8 Ld SOIC	M8.15E
(9317TS8IZ-2.7* (Note 1) X9317T ZG (9317TV8-2.7*, ** (Note 2) 317T F (9317TV8Z-2.7* (Note 1) 9317T FZ (9317TV8I-2.7*, ** (Note 2) 317T G	X9317TS8Z-2.7* (Note 1)	X9317T ZF			0 to +70	8 Ld SOIC (Pb-free)	M8.15E
(9317TV8-2.7*, ** (Note 2) 317T F 0 to +70 8 Ld TSSOP M8.173 (9317TV8Z-2.7* (Note 1) 9317T FZ 0 to +70 8 Ld TSSOP (Pb-free) M8.173 (9317TV8I-2.7*, ** (Note 2) 317T G -40 to +85 8 Ld TSSOP M8.173	X9317TS8I-2.7*, ** (Note 2)	X9317T G			-40 to +85	8 Ld SOIC	M8.15E
(9317TV8Z-2.7* (Note 1) 9317T FZ 0 to +70 8 Ld TSSOP (Pb-free) M8.173 (9317TV8I-2.7*, ** (Note 2) 317T G -40 to +85 8 Ld TSSOP M8.173	(9317TS8IZ-2.7* (Note 1)	X9317T ZG			-40 to +85	8 Ld SOIC (Pb-free)	M8.15E
(9317TV8I-2.7*, ** (Note 2) 317T G -40 to +85 8 Ld TSSOP M8.173	X9317TV8-2.7*, ** (Note 2)	317T F			0 to +70	8 Ld TSSOP	M8.173
	(9317TV8Z-2.7* (Note 1)	9317T FZ			0 to +70	8 Ld TSSOP (Pb-free)	M8.173
	X9317TV8I-2.7*, ** (Note 2)	317T G			-40 to +85	8 Ld TSSOP	M8.173
	X9317TV8IZ-2.7* (Note 1)	9317T GZ			-40 to +85	8 Ld TSSOP (Pb-free)	M8.173

*Add "T1" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

**Add "T2" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

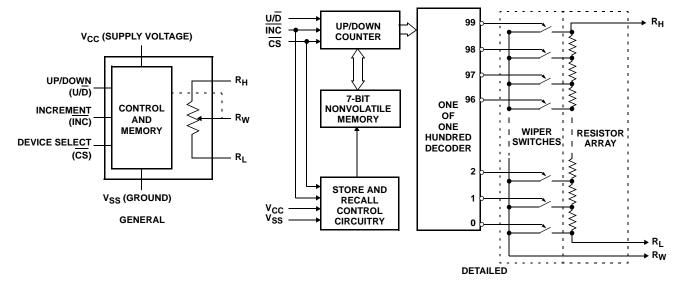
NOTES:

 These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

2. Not recommended for new designs.

4

Block Diagram



Pin Descriptions

PDIP/SOIC/MSOP	TSSOP	SYMBOL	BRIEF DESCRIPTION
1	3	INC	Increment Toggling \overline{INC} while \overline{CS} is low moves the wiper either up or down.
2	4	U/D	Up/Down The U/ \overline{D} input controls the direction of the wiper movement.
3	5	R _H	The high terminal is equivalent to one of the fixed terminals of a mechanical potentiometer.
4	6	V _{SS}	Ground
5	7	R _W	The wiper terminal is equivalent to the movable terminal of a mechanical potentiometer.
6	8	RL	The low terminal is equivalent to one of the fixed terminals of a mechanical potentiometer.
7	1	CS	Chip Select The device is selected when the \overline{CS} input is LOW, and de-selected when \overline{CS} is high.
8	2	V _{CC}	Supply Voltage

Absolute Maximum Ratings

I _W (10s)
R_{H} , R_{W} , R_{L} to Ground+6V
Voltage on CS, INC, U/D and V _{CC}
with Respect to V _{SS}

Thermal Information

Junction Temperature Under Bias	65°C to +135°C
Storage Temperature	65°C to +150°C
Pb-free reflow profile	see link below
http://www.intersil.com/pbfree/Pb-FreeRefle	ow.asp

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

SYMBOL	PARAMETER	TEST CONDITIONS/NOTES	MIN (Note 8)	TYP (Note 4)	MAX (Note 8)	UNIT
R _{TOTAL}	End-to-end Resistance Tolerance	See "Ordering Information" beginning on page 2 for values	-20		+20	%
V _{RH} / _{RL}	R _H /R _L Terminal Voltage	$V_{SS} = 0V$	V _{SS}		V _{CC}	V
	Power Rating	$R_{TOTAL} \ge 10 k\Omega$			10	mW
		R _{TOTAL} = 1kΩ			25	mW
R _W	Wiper Resistance	$I_W = [V(R_H) - V(R_L)]/R_{TOTAL}, V_{CC} = 5V$		200	400	Ω
		$I_{W} = [V(R_{H}) - V(R_{L})]/R_{TOTAL}, V_{CC} = 2.7V$		400	1000	Ω
IW	Wiper Current (Note 5)	See "Test Circuit" on page 7	-4.4		+4.4	mA
	Noise (Note 7)	Ref: 1kHz		-120		dB∖
	Resolution			1		%
	Absolute Linearity (Note 1)	$V(R_{H}) = V_{CC}, V(R_{L}) = 0V$	-1		+1	MI (Note
	Relative Linearity (Note 2)	$V(R_{H}) = V_{CC}, V(R_{L}) = 0V$	-0.2		+0.2	MI (Note
	R _{TOTAL} Temperature Coefficient (Note 5)	$V(R_{H}) = V_{CC}, V(R_{L}) = 0V$		±300		ppm/
	Ratiometric Temperature Coefficient (Notes 5, 6)			±20		ppm/
C _H /C _L /C _W (Note 5)	Potentiometer Capacitances	See "Equivalent Circuit" on page 7		10/10/25		pF
V _{CC}	Supply Voltage	X9317	4.5		5.5	V
		X9317-2.7	2.7		5.5	V

DC Electrical Specifications $V_{CC} = 5V \pm 10\%$, $T_A = Full Operating Temperature Range, unless otherwise stated.$

SYMBOL	PARAMETER	TEST CONDITIONS	MIN (Note 8)	TYP (Note 4)	MAX (Note 8)	UNIT
I _{CC1}	V _{CC} Active Current (Increment)	$\frac{\overline{CS}}{INC} = V_{IL}, U/\overline{D} = V_{IL} \text{ or } V_{IH} \text{ and}$ $\overline{INC} = V_{IL}/V_{IH} @ \text{ min. } t_{CYC}$ $R_L, R_H, R_W \text{ not connected}$			80	μA
I _{CC2}	V _{CC} Active Current (Store) (non-volatile write)	$\overline{CS} = V_{IH}, U/\overline{D} = V_{IL} \text{ or } V_{IH} \text{ and } \overline{INC} = V_{IL}$ or V_{IH} . R_L , R_H , R_W not connected			400	μA
I _{SB}	Standby Supply Current	$\label{eq:cs_limit} \begin{array}{l} \overline{CS} \geq V_{IH}, \mbox{ U/D} \mbox{ and } \overline{INC} = V_{IL} \\ R_L, \mbox{ R}_H, \mbox{ R}_W \mbox{ not connected} \end{array}$			5	μA
ILI	CS, INC, U/D Input Leakage Current	$V_{IN} = V_{SS}$ to V_{CC}	-10		+10	μA
V _{IH}	CS, INC, U/D Input HIGH Voltage		V _{CC} x 0.7		V _{CC} + 0.5	V
V _{IL}	CS, INC, U/D Input LOW Voltage		-0.5		V _{CC} x 0.1	V
C _{IN} (Note 5)	CS, INC, U/D Input Capacitance	$V_{CC} = 5V, V_{IN} = V_{SS}, T_A = +25^{\circ}C,$ f = 1MHz		10		pF

Endurance and Data Retention $V_{CC} = 5V \pm 10\%$, $T_A = Full Operating Temperature Range.$

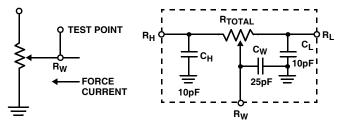
PARAMETER	MIN	UNIT
Minimum Endurance	100,000	Data changes per bit
Data Retention	100	Years

NOTES:

- Absolute linearity is utilized to determine actual wiper voltage versus expected voltage = [V(R_{W(n)(actual)})-V(R_{W(n)(expected)})]/MI V(R_{W(n)(expected)}) = n(V(R_H)-V(R_L))/99 + V(R_L), with n from 0 to 99.
- 2. Relative linearity is a measure of the error in step size between taps = $[V(R_{W(n+1)})-(V(R_{W(n)}) MI)]/MI$.
- 3. 1 MI = Minimum Increment = $[V(R_H)-V(R_L)]/99$.
- 4. Typical values are for $T_A = +25^{\circ}C$ and nominal supply voltage.
- 5. This parameter is not 100% tested.
- Ratiometric temperature coefficient = (V(R_W)_{T1(n)}-V(R_W)_{T2(n)})/[V(R_W)_{T1(n)}(T1-T2) x 10⁶], with T1 and T2 being 2 temperatures, and n from 0 to 99.
- 7. Measured with wiper at tap position 99, R_{L} grounded, using test circuit.
- Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.



Equivalent Circuit



AC Conditions of Test

Input pulse levels	0V to 3V
Input rise and fall times	10ns
Input reference levels	1.5V

AC Electrical Specifications $V_{CC} = 5V \pm 10\%$, $T_A = Full Operating Temperature Range$, unless otherwise stated.

SYMBOL	PARAMETER	MIN (Note 8)	TYP (Note 4)	MAX (Note 8)	UNIT
t _{Cl}	CS to INC Setup	50			ns
t _{ID} (Note 5)	INC HIGH to U/D Change	100			ns
t _{DI} (Note 5)	U/D to INC Setup	1			μs
t _{IL}	INC LOW Period	960			ns
tiH	INC HIGH Period	960			ns
t _{IC}	INC Inactive to CS Inactive	1			μs
t _{CPHS}	CS Deselect Time (STORE)	10			ms
^t CPHNS (Note 5)	CS Deselect Time (NO STORE)	100			ns
t _{IW}	INC to R _W Change		1	5	μs
tCYC	INC Cycle Time	2			μs
t _{R,} t _F (Note 5)	INC Input Rise and Fall Time			500	μs
t _{PU} (Note 5)	Power-up to Wiper Stable			5	μs
t _R V _{CC} (Note 5)	V _{CC} Power-up Rate	0.2		50	V/ms
t _{WR}	Store Cycle		5	10	ms

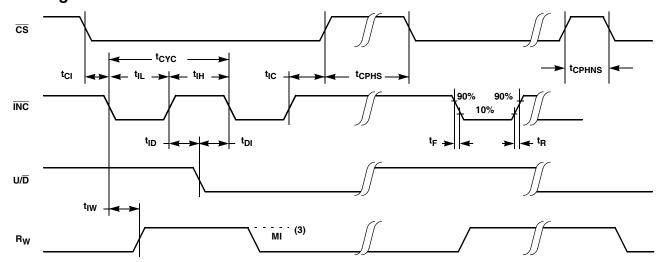
7

Power-up and Down Requirements

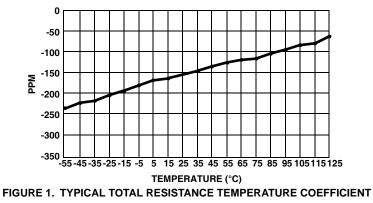
The recommended power-up sequence is to apply V_{CC}/V_{SS} first, then the potentiometer voltages. During power-up, the data sheet parameters for the DCP do not fully apply until

AC Timing

1ms after V_{CC} reaches its final value. The V_{CC} ramp spec is always in effect. In order to prevent unwanted tap position changes, or an inadvertent store, bring the \overline{CS} and \overline{INC} high before or concurrently with the V_{CC} pin on power-up.



Typical Performance Characteristic



Pin Descriptions

$R_H AND R_L$

The high (R_H) and low (R_L) terminals of the X9317 are equivalent to the fixed terminals of a mechanical potentiometer. The terminology of R_L and R_H references the relative position of the terminal in relation to wiper movement direction selected by the U/ \overline{D} input and not the voltage potential on the terminal.

R_{W}

 R_w is the wiper terminal and is equivalent to the movable terminal of a mechanical potentiometer. The position of the wiper within the array is determined by the control inputs. The wiper terminal series resistance is typically 200 Ω .

UP/DOWN (U/D)

The U/\overline{D} input controls the direction of the wiper movement and whether the counter is incremented or decremented.

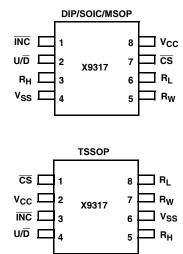
INCREMENT (INC)

The $\overline{\text{INC}}$ input is negative-edge triggered. Toggling $\overline{\text{INC}}$ will move the wiper and either increment or decrement the counter in the direction indicated by the logic level on the U/\overline{D} input.

CHIP SELECT (CS)

The device is selected when the \overline{CS} input is LOW. The current counter value is stored in nonvolatile memory when \overline{CS} is returned HIGH while the \overline{INC} input is also HIGH. After the store operation is complete, the X9317 will be placed in the low power standby mode until the device is selected once again.

Pin Configuration



Pin Names

SYMBOL	DESCRIPTION
R _H	High terminal
RW	Wiper terminal
RL	Low terminal
V _{SS}	Ground
V _{CC}	Supply voltage
U/D	Up/Down control input
INC	Increment control input
CS	Chip select control input

Principles of Operation

There are three sections of the X9317: the control section, the nonvolatile memory, and the resistor array. The control section operates just like an up/down counter. The output of this counter is decoded to turn on a single electronic switch connecting a point on the resistor array to the wiper output. The contents of the counter can be stored in nonvolatile memory and retained for future use. The resistor array is comprised of 99 individual resistors connected in series. Electronic switches at either end of the array and between each resistor provide an electrical connection to the wiper pin, R_W .

The wiper acts like its mechanical equivalent and does not move beyond the first or last position. That is, the counter does not wrap around when clocked to either extreme.

The electronic switches on the device operate in a "make before break" mode when the wiper changes tap positions. If the wiper is moved several positions, multiple taps are connected to the wiper for t_{IW} (INC to V_W change). The R_{TOTAL} value for the device can temporarily be reduced by a significant amount if the wiper is moved several positions.

When the device is powered-down, the last wiper position stored will be maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the wiper is set to the value last stored.

Instructions and Programming

The \overline{INC} , U/\overline{D} and \overline{CS} inputs control the movement of the wiper along the resistor array. With \overline{CS} set LOW, the device is selected and enabled to respond to the U/\overline{D} and \overline{INC} inputs. HIGH to LOW transitions on \overline{INC} will increment or decrement (depending on the state of the U/\overline{D} input) a 7-bit counter. The output of this counter is decoded to select one of one hundred wiper positions along the resistive array.

The value of the counter is stored in nonvolatile memory whenever $\overline{\text{CS}}$ transitions HIGH while the $\overline{\text{INC}}$ input is also HIGH.

9

The system may select the X9317, move the wiper and deselect the device without having to store the latest wiper position in nonvolatile memory. After the wiper movement is performed as previously described and once the new position is reached, the system must keep INC LOW while taking CS HIGH. The new wiper position will be maintained until changed by the system or until a power-up/down cycle recalls the previously stored data.

This procedure allows the system to always power-up to a preset value stored in nonvolatile memory; then during system operation minor adjustments could be made. The adjustments might be based on user preference, system parameter changes due to temperature drift, etc.

The state of U/\overline{D} may be changed while \overline{CS} remains LOW. This allows the host system to enable the device and then move the wiper up and down until the proper trim is attained.

Mode Selection

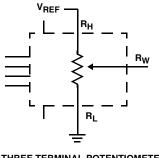
CS	INC	U/D	MODE
L	~	Н	Wiper up
L		L	Wiper down
_	Н	Х	Store wiper position to nonvolatile memory
Н	Х	Х	Standby
	L	Х	No store, return to standby
~_	L	Н	Wiper Up (not recommended)
~	L	L	Wiper Down (not recommended)

Applications Information

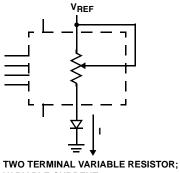
Electronic digitally controlled (XDCP) potentiometers provide three powerful application advantages:

- 1. the variability and reliability of a solid-state potentiometer,
- 2. the flexibility of computer-based digital controls, and
- 3. the retentivity of nonvolatile memory used for the storage of multiple potentiometer settings or data.

Basic Configurations of Electronic Potentiometers

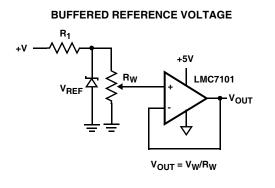


THREE TERMINAL POTENTIOMETER; VARIABLE VOLTAGE DIVIDER



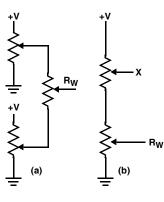
VARIABLE CURRENT

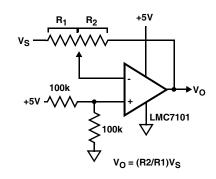
Basic Circuits



CASCADING TECHNIQUES

SINGLE SUPPLY INVERTING AMPLIFIER

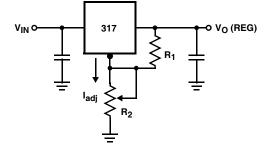




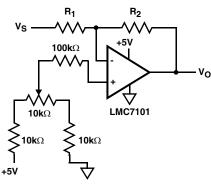
VOLTAGE REGULATOR

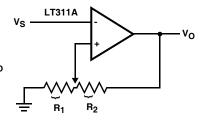
OFFSET VOLTAGE ADJUSTMENT

COMPARATOR WITH HYSTERESIS

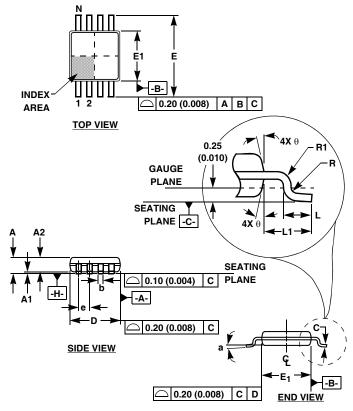


 V_{O} (REG) = 1.25V (1+R₂/R₁)+I_{adj} R₂





$$\begin{split} V_{UL} &= \{ R_1 / (R_1 + R_2) \} \ V_O(max) \\ V_{LL} &= \{ R_1 / (R_1 + R_2) \} \ V_O(min) \end{split}$$



Mini Small Outline Plastic Packages (MSOP)

NOTES:

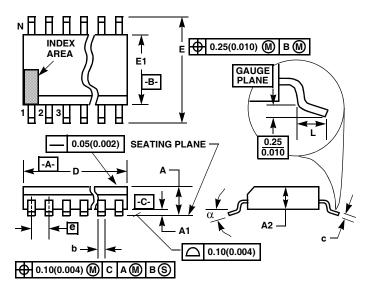
- 1. These package dimensions are within allowable dimensions of JEDEC MO-187BA.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1994.
- 3. Dimension "D" does not include mold flash, protrusions or gate burrs and are measured at Datum Plane. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- 4. Dimension "E1" does not include interlead flash or protrusions and are measured at Datum Plane. <u>-H-</u> Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- 5. Formed leads shall be planar with respect to one another within 0.10mm (0.004) at seating Plane.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- 10. Datums -A and -B to be determined at Datum plane
- 11. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only.

M8.118 (JEDEC MO-187AA)

8 LEAD MINI SMALL OUTLINE PLASTIC PACKAGE

	INC	HES	MILLIN	MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MAX	NOTES	
A	0.037	0.043	0.94	1.10	-	
A1	0.002	0.006	0.05	0.15	-	
A2	0.030	0.037	0.75	0.95	-	
b	0.010	0.014	0.25	0.36	9	
С	0.004	0.008	0.09	0.20	-	
D	0.116	0.120	2.95	3.05	3	
E1	0.116	0.120	2.95	3.05	4	
е	0.026	BSC	0.65 BSC		-	
E	0.187	0.199	4.75 5.05		-	
L	0.016	0.028	0.40	0.70	6	
L1	0.037	0.037 REF		0.95 REF		
Ν	8	8		8		
R	0.003	-	0.07	-	-	
R1	0.003	-	0.07	-	-	
0	5 ⁰	15 ⁰	5 ⁰	15 ⁰	-	
α	0 ⁰	6 ⁰	0 ⁰	6 ⁰	-	
<u>.</u>				F	ev. 2 01/03	

Thin Shrink Small Outline Plastic Packages (TSSOP)



NOTES:

- 1. These package dimensions are within allowable dimensions of JEDEC MO-153-AC, Issue E.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

M8.173

8 LEAD THIN SHRINK NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

	INC	HES	MILLIM		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
Α	-	0.047	-	1.20	-
A1	0.002	0.006	0.05	0.15	-
A2	0.031	0.051	0.80	1.05	-
b	0.0075	0.0118	0.19	0.30	9
с	0.0035	0.0079	0.09	0.20	-
D	0.116	0.120	2.95	3.05	3
E1	0.169	0.177	4.30	4.50	4
е	0.026	0.026 BSC		0.65 BSC	
E	0.246	0.256	6.25	6.50	-
L	0.0177	0.0295	0.45	0.75	6
N	8	3	1	3	7
α	0 ⁰	8 ⁰	0 ⁰	8 ⁰	-
	•		•		N/ 1 12/00

Rev. 1 12/00

 0.22 ± 0.03

 $4^{\circ} \pm 4^{\circ}$

0.25

GAUGE PLANE

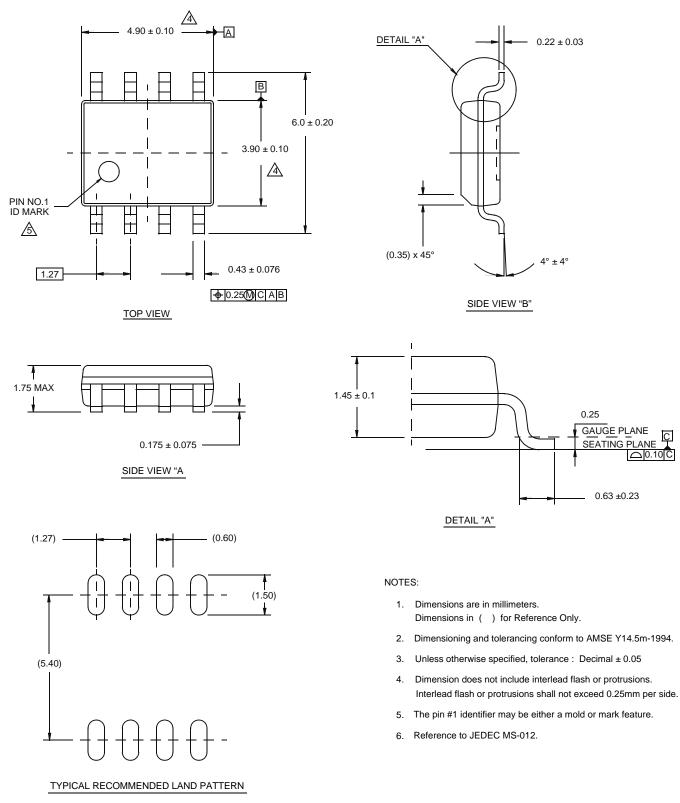
0.63 ±0.23

0.10 C

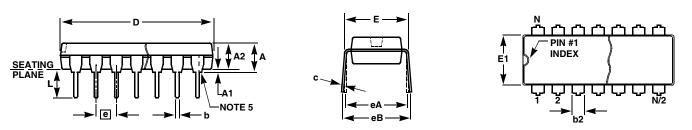
Package Outline Drawing

M8.15E

8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE Rev 0, 08/09



Plastic Dual-In-Line Packages (PDIP)



MDP0031 PLASTIC DUAL-IN-LINE PACKAGE

NOTES	TOLERANCE		INCHES				
		PDIP20	PDIP18	PDIP16	PDIP14	PDIP8	SYMBOL
	MAX	0.210	0.210	0.210	0.210	0.210	А
	MIN	0.015	0.015	0.015	0.015	0.015	A1
	±0.005	0.130	0.130	0.130	0.130	0.130	A2
	±0.002	0.018	0.018	0.018	0.018	0.018	b
	+0.010/-0.015	0.060	0.060	0.060	0.060	0.060	b2
	+0.004/-0.002	0.010	0.010	0.010	0.010	0.010	с
1	±0.010	1.020	0.890	0.750	0.750	0.375	D
	+0.015/-0.010	0.310	0.310	0.310	0.310	0.310	E
2	±0.005	0.250	0.250	0.250	0.250	0.250	E1
	Basic	0.100	0.100	0.100	0.100	0.100	е
	Basic	0.300	0.300	0.300	0.300	0.300	eA
	±0.025	0.345	0.345	0.345	0.345	0.345	eB
	±0.010	0.125	0.125	0.125	0.125	0.125	L
	Reference	20	18	16	14	8	Ν

NOTES:

1. Plastic or metal protrusions of 0.010" maximum per side are not included.

2. Plastic interlead protrusions of 0.010" maximum per side are not included.

3. Dimensions E and eA are measured with the leads constrained perpendicular to the seating plane.

4. Dimension eB is measured with the lead tips unconstrained.

5. 8 and 16 lead packages have half end-leads as shown.

All Intersil U.S. products are manufactured, assembled and tested utilizing ISO9000 quality systems. Intersil Corporation's quality certifications can be viewed at www.intersil.com/design/quality

Intersil products are sold by description only. Intersil Corporation reserves the right to make changes in circuit design, software and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com

